## NB3N508S

# 3.3V, 216 MHz PureEdge VCXO Clock Generator with M-LVDS Output 

## Description

The NB3N508S is a high precision, low phase noise Voltage Controlled Crystal Oscillator (VCXO) and phase lock loop (PLL) that generates 216 MHz M-LVDS output from a 27 MHz crystal. The $\pm 100 \mathrm{ppm}$ output pullable range is obtained using the $\mathrm{V}_{\text {IN }}$ pin of the VCXO with usable range from 0 V to 3.3 V . The VCXO input pin $\mathrm{V}_{\text {IN }}$ is a high-impedance input that can be driven directly from a pulse width modulated RC integrator circuit.

The NB3N508S is designed primarily for data and clock recovery applications within end products such as ADSL modems, set-top box receivers, and telecom systems. This device is housed in $5.0 \mathrm{~mm} x$ 4.4 mm narrow body TSSOP-16 pin package.

## Features

- PureEdge Clock Family Provides Accuracy and Precision
- Performs Precision Clock Multiplication from 27 MHz Crystal
- Uses 27 MHz Fundamental Mode Crystal
- External Loop Filter is Not Required
- 216 MHz M-LVDS Output
- VCXO with Pull Range $\pm 100 \mathrm{ppm}$
- 0 V to 3.3 V VCXO Tuning Voltage Range Capabilities
- Phase Noise:

| Offset | Noise Powe |
| :--- | :--- |
| 100 Hz | -80 dBc |
| 1 kHz | -88 dBc |
| 10 kHz | -105 dBc |
| 100 kHz | -106 dBc |
| 1 MHz | -120 dBc |
| 10 MHz | -145 dBc |

- Operating Range $3.3 \mathrm{~V} \pm 5 \%$
- These are $\mathrm{Pb}-$ Free Devices*

ON Semiconductor ${ }^{\circledR}$
http://onsemi.com


A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

- $\quad=$ Pb-Free Package
(Note: Microdot may be in either location)


## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

*For additional information on our Pb -Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.


Figure 2. Pin Configuration (Top View)

Table 1. PIN DESCRIPTION

| Pin | Name | I/O |  |
| :---: | :---: | :---: | :--- |
| 1 | $\mathrm{X}^{\prime}$ | Crystal Input | Crystal input(IN). Connect to a 27 MHz crystal. |
| $2,3,4,10$ | $\mathrm{~V}_{\mathrm{DD}}$ | Power Supply | Positive power supply voltage. |
| 5 | $\mathrm{~V}_{\mathrm{IN}}$ | Input | Analog voltage input pin that controls output oscillation frequencies. $\mathrm{V}_{\text {IN }}$ pin range is <br> from 0 V to 3.3 V . $\mathrm{V}_{\text {IN }}$ Voltage should not exceed $\mathrm{V}_{\mathrm{DD}}$ |
| $6,7,8,12$ | GND | Power Supply | Ground 0 V . These pins provide GND return path for the devices. |
| $9,11,15$ | NC | - | No Connect. |
| 13 | CLK | M-LVDS Output | Inverted clock output. Typically loaded with $50 \Omega$ receiver termination resistor across <br> diff. pair. |
| 14 | CLK | M-LVDS Output | Noninverted clock output. Typically loaded with $50 \Omega$ receiver termination resistor <br> across diff. pair. |
| 16 | X2 | Crystal Input | Crystal input(OUT). Connect to a 27 MHz crystal. |

## Recommended Crystal Parameters

Crystal Fundamental AT-Cut Frequency 27 MHz
Load Capacitance
14 pF
Shunt Capacitance, C0
Max Equivalent Series Resistance
Max Initial Accuracy at $25^{\circ} \mathrm{C}$
Temperature Stability
Aging
7 pF
$35 \Omega$
$\pm 20 \mathrm{ppm}$
$\pm 30 \mathrm{ppm}$
C0/C1 Ration 250 Max

## NB3N508S

Table 2. ATTRIBUTES

| Characteristics | Value |
| :--- | :---: |
| ESD ProtectionHuman Body Model <br> Machine Model | $>4 \mathrm{kV}$ <br> $>400 \mathrm{~V}$ |
| Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1) |  |
| TSSOP-16 |  |$\quad$| Level 3 |
| :--- |

1. For additional information, see Application Note AND8003/D.

Table 3. MAXIMUM RATINGS

| Symbol | Parameter | Condition 1 | Condition 2 | Rating | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{D D}$ | Positive Power Supply | GND $=0 \mathrm{~V}$ |  | 4.6 | V |
| $V_{1}$ | Input Voltage ( $\mathrm{V}_{\text {IN }}$ ) | $\mathrm{GND}=0 \mathrm{~V}$ | $\mathrm{GND} \leq \mathrm{V}_{\mathrm{I}} \leq \mathrm{V}_{\mathrm{DD}}$ | $V_{\text {DD }}$ | V |
| Iout | M-LVDS Output Current | Continuous Surge |  | $\begin{aligned} & 25 \\ & 50 \end{aligned}$ | $\begin{aligned} & \mathrm{mA} \\ & \mathrm{~mA} \end{aligned}$ |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature Range |  |  | 0 to +70 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range |  |  | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\mathrm{JA}}$ | Thermal Resistance (Junction-to-Ambient) | 0 lfpm 500 lfpm | $\begin{aligned} & \hline \text { TSSOP-16 } \\ & \text { TSSOP-16 } \end{aligned}$ | $\begin{aligned} & 138 \\ & 108 \end{aligned}$ | $\begin{aligned} & \hline{ }^{\circ} \mathrm{C} / \mathrm{W} \\ & { }^{\circ} \mathrm{C} / \mathrm{W} \end{aligned}$ |
| $\theta_{\text {JA }}$ | Thermal Resistance (Junction-to-Case) | (Note 2) | TSSOP-16 | 33 to 36 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| T SOL | Wave Solder Pb-Free |  |  | 265 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.
2. JEDEC standard multilayer board - 2S2P (2 Signal, 2 Power).

Table 4. DC CHARACTERISTICS $\left(\mathrm{V}_{\mathrm{DD}}=3.135 \mathrm{~V}\right.$ to $3.465 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $\left.+70^{\circ} \mathrm{C}\right)$

| Symbol | Characteristic | Min | Typ | Max | Unit |
| :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{DD}}$ | Power Supply Current (outputs loaded with $\mathrm{R}_{\mathrm{L}}=50 \Omega$ ) | 42 | 52 | 62 | mA |
| $\mathrm{~V}_{\mathrm{IA}}$ | VCXO Control Voltage, $\mathrm{V}_{\text {IN }}$ | 0 |  | 3.3 | V |
| $\mathrm{~V}_{\mathrm{OD}}$ | Differential Output Voltage (Note 3) | 480 | 565 | 650 | mV |
| $\Delta \mathrm{V}_{\mathrm{OD}}$ | Change in Magnitude of $\mathrm{V}_{\mathrm{OD}}$ for Complementary Output States <br> (Notes 3, 6) | -50 |  | 50 | mV |
| $\mathrm{V}_{\mathrm{OS}}$ | Offset Voltage (See Figure 4) | 300 |  | 2100 | mV |
| $\Delta \mathrm{V}_{\mathrm{OS}}$ | Change in Magnitude of $\mathrm{V}_{\text {Os }}$ for Complementary Output States <br> (Note 6) | -50 |  | 50 | mV |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage (Note 4) |  | 1300 | 2425 | mV |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage (Note 5) | -25 | 700 |  | mV |
| $\mathrm{I}_{\mathrm{SC}}$ | Output Short Circuit Current |  |  | 43 | mA |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm . Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.
3. M-LVDS outputs require $50 \Omega$ receiver termination resistor between differential. pair. See Figure 3
4. $\mathrm{V}_{\text {OHmax }}=\mathrm{V}_{\text {OSmax }}+1 / 2 \mathrm{~V}_{\text {ODmax }}$.
5. $\mathrm{V}_{\text {OLmax }}=\mathrm{V}_{\text {OSmin }}-1 / 2 \mathrm{~V}_{\text {ODmax }}$.
6. Parameters guaranteed by design but not tested in production.

## NB3N508S

Table 5. AC CHARACTERISTICS ( $\mathrm{V}_{\mathrm{DD}}=3.135 \mathrm{~V}$ to $3.465 \mathrm{~V}, \mathrm{GND}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=0^{\circ} \mathrm{C}$ to $+70^{\circ} \mathrm{C}$, Note 7)

| Symbol | Characteristic | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {CLKIN }}$ | Crystal Input Frequency |  | 27 |  | MHz |
| $\mathrm{f}_{\text {CLKOUT }}$ | Output Clock Frequency |  | 216 |  | MHz |
| $\Phi_{\text {NOISE }}$ | Phase-Noise Performance $\mathrm{f}_{\text {CLKOUT }}=216 \mathrm{MHz}$ <br> @ 100 Hz Offset from Carrier <br> @ 1 kHz Offset from Carrier <br> @ 10 kHz Offset from Carrier <br> @ 100 kHz Offset from Carrier <br> @ 1 MHz Offset from Carrier <br> @ 10 MHz Offset from Carrier |  | $\begin{gathered} -80 \\ -88 \\ -105 \\ -106 \\ -120 \\ -145 \end{gathered}$ |  | $\mathrm{dBc} / \mathrm{Hz}$ |
|  | Spurious Noise Components |  | -60 |  | $\mathrm{dBc} / \mathrm{Hz}$ |
| $\mathrm{F}_{\mathrm{P}}$ | Crystal Pullability $0 \mathrm{~V} \leq \mathrm{V}_{\mathrm{IN}} \leq 3.3 \mathrm{~V}$ | $\pm 100$ |  |  | ppm |
| tDUTY_CYCLE | Output Clock Duty Cycle (Measured at Crosspoint) | 45 | 50 | 55 | \% |
| $\mathrm{t}_{\mathrm{R}}$ | Output Rise Time (CLK/CLK) (Note 8) |  | 380 | 500 | ps |
| $\mathrm{t}_{\mathrm{F}}$ | Output Fall Time (CLK/CLK) (Note 8) |  | 380 | 500 | ps |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm . Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.
7. CLK/CLK loaded with $50 \Omega$ receiver termination resistor between diff. pair.
8. Measured differentially (CLK - $\overline{C L K}$ ) at $10 \%$ to $90 \%$; $R_{L}=50 \Omega$.


Figure 3. Typical Phase Noise Plot ( $\mathrm{V}_{\mathrm{DD}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{IN}}=\mathbf{0} \mathrm{V}$; Room Temperature)

## NB3N508S




Figure 6. Typical Crystal Startup Time with $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ at Ambient Temperature ( 1.99 ms )


Figure 7. Typical Crystal Startup Time with $\mathrm{V}_{\mathrm{IN}}=3.3 \mathrm{~V}$ at Ambient Temperature ( $694 \mu \mathrm{~s}$ )


Figure 8. Typical Termination for Output Driver and Device Evaluation


Figure 9. H-LVDS Output

## NB3N508S

ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :--- | :---: | :---: |
| NB3N508SDTG | TSSOP-16 <br> (Pb-Free) | 96 Units / Rail |
| NB3N508SDTR2G | TSSOP-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.


TSSOP-16
CASE 948F-01
ISSUE B
DATE 19 OCT 2006

SCALE 2:1


| DOCUMENT NUMBER: | 98ASH70247A | Electronic versions are uncontrolled except when accessed directly from the Document Repository. <br> Printed versions are uncontroled except when stamped "CONTROLLED COPY" in red. |
| ---: | :--- | :--- | :--- |
| DESCRIPTION: | TSSOP-16 | PAGE 1 OF 1 |

ON Semiconductor and (ON) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the disclaims any and
rights of others.

ON Semiconductor and $O N$ are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. Typical parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

## LITERATURE FULFILLMENT

Email Requests to: orderlit@onsemi.com
ON Semiconductor Website: www.onsemi.com

Europe, Middle East and Africa Technical Support:
Phone: 00421337902910
For additional information, please contact your local Sales Representative

